

MOSFET

OptiMOS[™] Small Signal Transistor, -60 V

Features

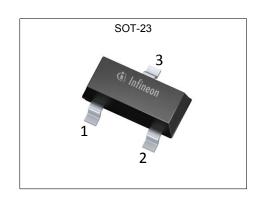
- P-Channel
- Very low on-resistance $R_{\rm DS(on)}$ @ $V_{\rm GS}$ =4.5 V 100% avalanche tested
- Logic Level
- Enhancement mode
- Pb-free lead plating; RoHS compliant
- Halogen-free according to IEC61249-2-21

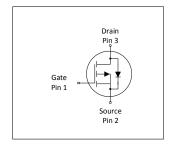
Product validation

Fully qualified according to JEDEC for Industrial Applications

Kev Performance Parameters Table 1

Table 1 1toy 1 differentianted 1 arameters								
Parameter	Value	Unit						
V _{DS}	-60	V						
R _{DS(on),max}	5.5	Ω						
I_{D}	-0.18	A						











Type / Ordering Code	Package	Marking	Related Links
ISS55EP06LM	PG-SOT23	CL	-

OptiMOS[™] Small Signal Transistor, -60 V



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OptiMOS[™] Small Signal Transistor, -60 V ISS55EP06LM



1 Maximum ratings at T_A =25 °C, unless otherwise specified

Table 2 **Maximum ratings**

Danamatan	Ob. a.l	Values				
Parameter	Symbol	Min.	Тур.	Max.	Unit	Note / Test Condition
Continuous drain current ¹⁾	I _D	-	-	-0.18	Α	V _{GS} =-10 V, T _A =25 °C
Continuous drain current ¹⁾	I _D	- - -	-	-0.12 -0.16 -0.10	A	V _{GS} =-10 V, T _A =100 °C V _{GS} =-4.5 V, T _A =25 °C V _{GS} =-4.5 V, T _A =100 °C
Pulsed drain current ²⁾	I _{D,pulse}	-	-	-0.72	Α	<i>T</i> _A =25 °C
Avalanche energy, single pulse ³⁾	E AS	-	-	4.3	mJ	$I_{\rm D}$ =-0.18 A, $R_{\rm GS}$ =25 Ω
Gate source voltage	V _{GS}	-20	-	20	V	-
Power dissipation	P _{tot}	-	-	0.4	W	T _A =25 °C, R _{THJA} =350 °C/W
Operating and storage temperature	T _j , T _{stg}	-55	-	150	°C	IEC climatic category; DIN IEC 68-1: 55/150/56

Thermal characteristics 2

Table 3 **Thermal characteristics**

Parameter	Symbol	Values			Unit	Note / Test Condition
Farameter	Symbol	Min.	Тур.	Max.	Ullit	Note / Test Condition
Thermal resistance, junction - soldering point	R _{thJS}	-	-	130	°C/W	-
Device on PCB, minimum footprint ¹⁾	R _{thJA}	-	-	350	°C/W	-

¹⁾ Device on 40 mm x 40 mm x 1.5 mm epoxy PCB FR4 (one layer, 70 µm thick), minimum footprint. PCB is vertical in 2) See Diagram 3 for more detailed information 3) See Diagram 13 for more detailed information

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3 Electrical characteristics at T_j =25 °C, unless otherwise specified

Table 4 **Static characteristics**

Parameter	0		Values			
	Symbol	Min.	Тур.	Max.	Unit	Note / Test Condition
Drain-source breakdown voltage	V _{(BR)DSS}	-60	-	-	V	V _{GS} =0 V, I _D =-250 μA
Gate threshold voltage	V _{GS(th)}	-1	-1.5	-2	V	$V_{\rm DS}=V_{\rm GS},\ I_{\rm D}=-11\ \mu {\rm A}$
Zero gate voltage drain current	I _{DSS}	-	-0.1 -10	-1 -100	μA	V _{DS} =-60 V, V _{GS} =0 V, T _j =25 °C V _{DS} =-60 V, V _{GS} =0 V, T _j =125 °C
Gate-source leakage current	I _{GSS}	-	-10	-100	nA	V _{GS} =-20 V, V _{DS} =0 V
Drain-source on-state resistance	R _{DS(on)}	-	4344 5240	5500 7000	mΩ	V _{GS} =-10 V, I _D =-0.18 A V _{GS} =-4.5 V, I _D =-0.16 A
Gate resistance	R _G	-	45	-	Ω	-
Transconductance	g fs	-	0.28	-	S	$ V_{DS} \ge 2 I_D R_{DS(on)max}, I_D = -0.18 \text{ A}$

Table 5 **Dynamic characteristics**

Paramatan	Symbol	Values			1114	Note / Tool Oo william
Parameter		Min.	Тур.	Max.	Unit	Note / Test Condition
Input capacitance	Ciss	-	18	-	pF	V _{GS} =0 V, V _{DS} =-30 V, f=1 MHz
Output capacitance	Coss	-	3.4	-	pF	V _{GS} =0 V, V _{DS} =-30 V, f=1 MHz
Reverse transfer capacitance	C _{rss}	-	1.2	-	pF	V _{GS} =0 V, V _{DS} =-30 V, f=1 MHz
Turn-on delay time	$t_{\sf d(on)}$	-	1.0	-	ns	$V_{\rm DD}$ =-30 V, $V_{\rm GS}$ =-10 V, $I_{\rm D}$ =-0.18 A, $R_{\rm G,ext}$ =1.6 Ω
Rise time	t _r	-	1.4	-	ns	$V_{\rm DD}$ =-30 V, $V_{\rm GS}$ =-10 V, $I_{\rm D}$ =-0.18 A, $R_{\rm G,ext}$ =1.6 Ω
Turn-off delay time	$t_{ m d(off)}$	-	4.9	-	ns	$V_{\rm DD}$ =-30 V, $V_{\rm GS}$ =-10 V, $I_{\rm D}$ =-0.18 A, $R_{\rm G,ext}$ =1.6 Ω
Fall time	t _f	-	1.2	-	ns	$V_{\rm DD}$ =-30 V, $V_{\rm GS}$ =-10 V, $I_{\rm D}$ =-0.18 A, $R_{\rm G,ext}$ =1.6 Ω

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Table 6 Gate charge characteristics¹⁾

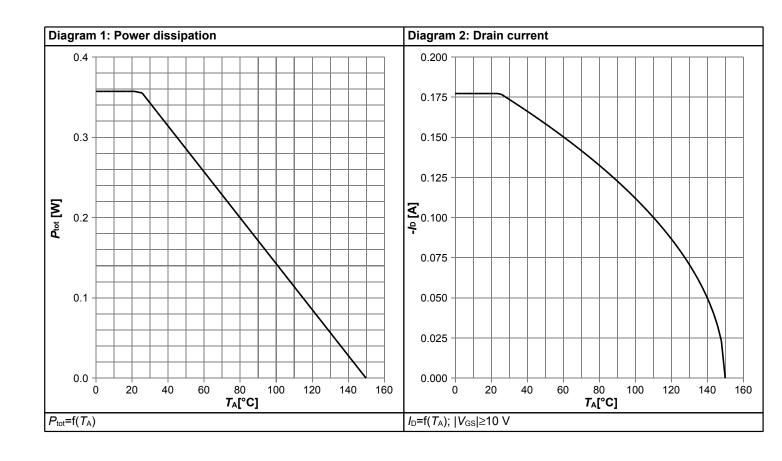
Parameter	Cumbal	Values			Unit	Note / Test Condition
Parameter	Symbol	Min.	Тур.	Max.	Unit	Note / Test Condition
Gate to source charge	Q _{gs}	-	-0.06	-	nC	V_{DD} =-30 V, I_{D} =-0.18 A, V_{GS} =0 to -10 V
Gate charge at threshold	$Q_{g(th)}$	-	-0.03	-	nC	V_{DD} =-30 V, I_{D} =-0.18 A, V_{GS} =0 to -10 V
Gate to drain charge	$Q_{ m gd}$	-	-0.17	-	nC	V _{DD} =-30 V, I _D =-0.18 A, V _{GS} =0 to -10 V
Switching charge	Q _{sw}	-	-0.21	-	nC	V _{DD} =-30 V, I _D =-0.18 A, V _{GS} =0 to -10 V
Gate charge total	Qg	-	-0.59	-	nC	V_{DD} =-30 V, I_{D} =-0.18 A, V_{GS} =0 to -10 V
Gate plateau voltage	V _{plateau}	-	-3.5	-	V	V _{DD} =-30 V, I _D =-0.18 A, V _{GS} =0 to -10 V
Output charge	Qoss	-	-0.20	-	nC	V _{DD} =-30 V, V _{GS} =0 V

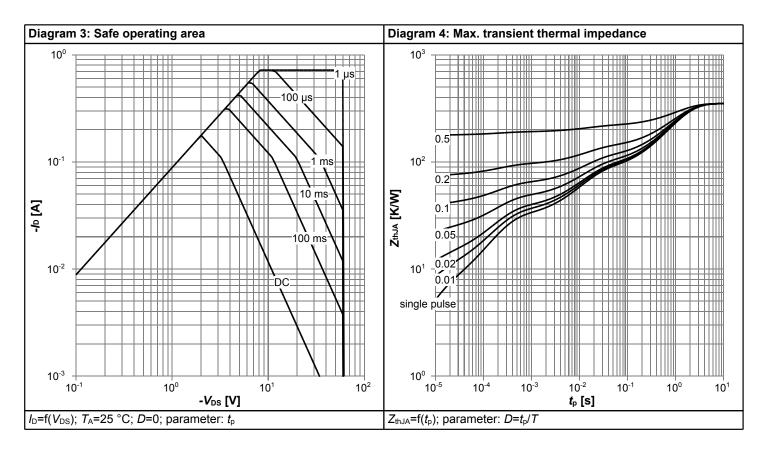
Table 7 Reverse diode

Parameter	Symbol	Values			Unit	Nata / Tant Candition
Parameter		Min.	Тур.	Max.	Ullit	Note / Test Condition
Diode continuous forward current	<i>I</i> s	-	-	-0.18	Α	T _A =25 °C
Diode pulse current	I _{S,pulse}	-	-	-0.72	Α	T _A =25 °C
Diode forward voltage	V _{SD}	-	-0.9	-1.2	V	V _{GS} =0 V, I _F =-0.18 A, T _j =25 °C
Reverse recovery time	t _{rr}	-	10	-	ns	V_R =-30 V, I_F =-0.18 A, d_{I_F}/dt =-100 A/ μ s
Reverse recovery charge	Qrr	-	-5	-	nC	V _R =-30 V, I _F =-0.18 A, d <i>i</i> _F /d <i>t</i> =-100 A/μs

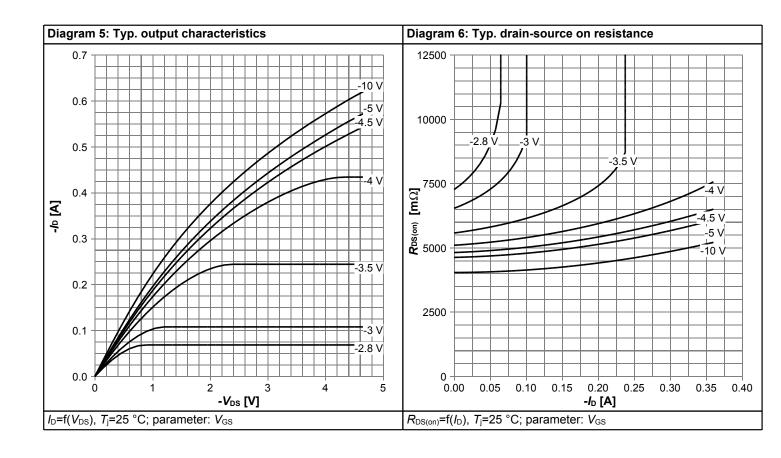


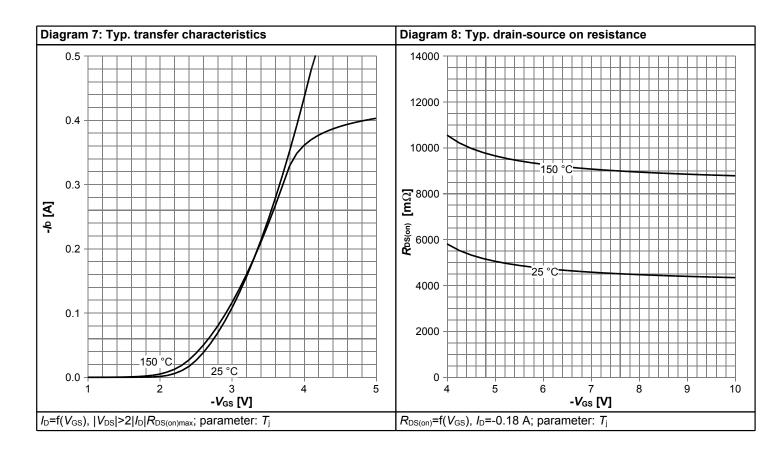
4 Electrical characteristics diagrams



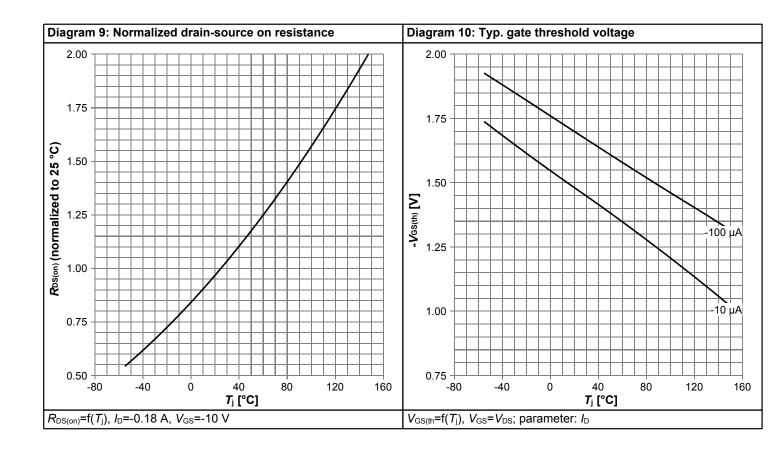


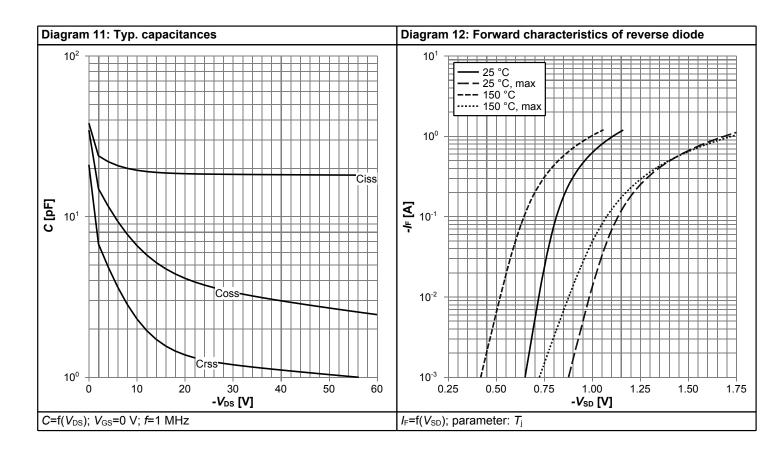




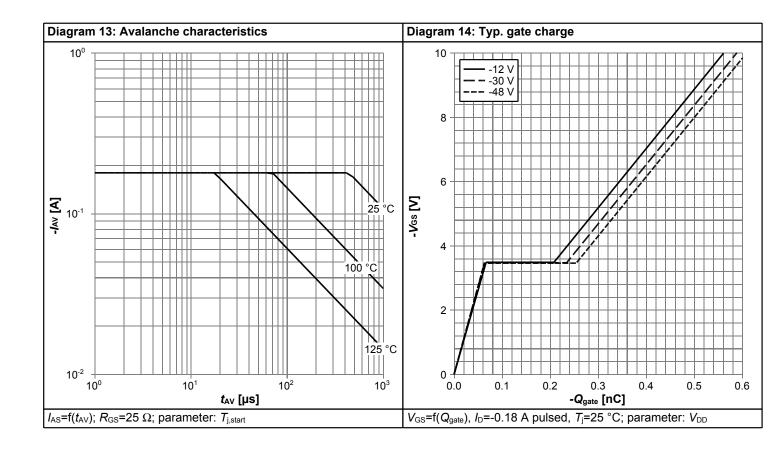


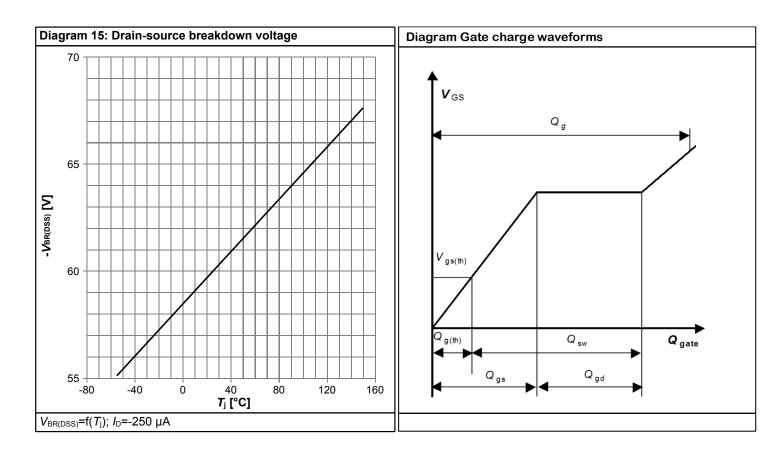








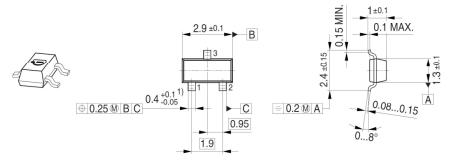






5 Package Outlines

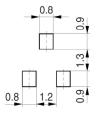
Package Outline



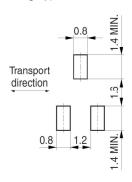
1) Lead width can be 0.6 max. in dambar area

Foot Print

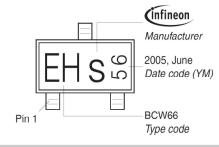
Soldering Type: Reflow Soldering



Soldering Type: Wave Soldering



Marking Layout (Example)



Tape and Reel

Reel ø 180 mm: 3.000 Pieces/Reel Reels/Box: 1 x 3.000 = 3.000 Reels/Box: 10 x 3.000 - 30.000

Reel ø330 mm: 10.000 Pieces/Reel Reels/Box: 1 x 10.000 = 10.000

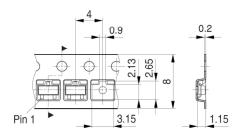


Figure 1 Outline PG-SOT23, dimensions in mm

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Revision History

ISS55EP06LM

Revision: 2019-04-03, Rev. 2.0

Provious Povision

Previous Revision						
Revision	Date	Subjects (major changes since last revision)				
2.0	2019-04-03	Release of final version				

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